

LEADED

# BGA SOLDER PASTE

● ● ●  
Sn63/Pb37

Melting point 183°C



## Product Usage

● ● ●  
TIN PASTE

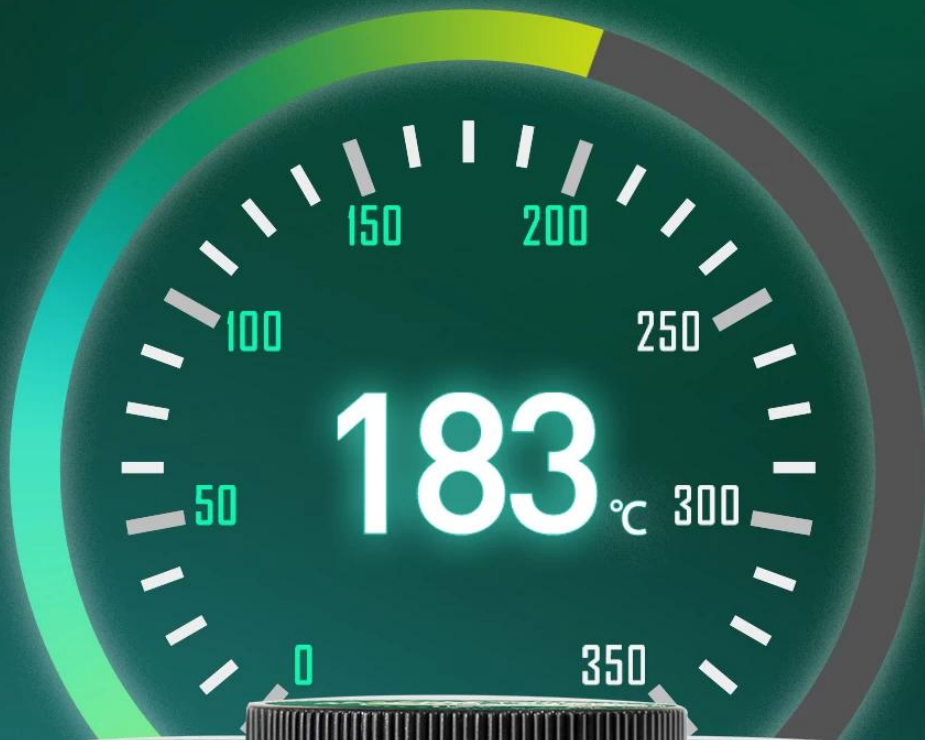
Type number	BST-506
Types of	Solder Paste
Composition	Sn63/Pb37
Melting point	183°C
G.W.	50g
size	36*36mm



Sn63/Pb37

Melting point at medium temperature

183°C





Low residue



Solder spot bright

Rapid welding

# Welding requirements for a wide range of products



**SMT  
patch**



**LED  
patch**



**BGA  
welding**



# Product List

G.W.:50g

